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JUN 29 2005

Customer No.: 31561
Application No.: 10/605,163
Docket No.: 10230-US-PA

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:)
WANG, SUNG-FEI) Examiner: WILLIAMS, ALEXANDER O
Serial No.: 10/605,163) Art Unit: 2826
Filed: 09/12/2003) Docket No.: 10230-US-PA
For: SEMICONDUCTOR PACKAGE WITH)
A HEAT SPREADER)

No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No.: 10230-US-PA)

REQUEST FOR CONTINUED EXAMINATION/ PRELIMINARY AMENDMENT

U.S. Patent and Trademark Office
Commissioner for Patents
Customer Service Window Mail Stop RCE
Randolph Building, 401 Dulany Street
Alexandria, VA 22314

Sir:

The Advisory Action mailed May 4, 2005 has been carefully considered. In response thereto, Applicant respectfully files a Request for Continued Examination (RCE). Please enter the following amendments and consider the following remarks.

06/29/2005 TL0111 00000025 502620 10605163
02 FC:1252 450.00 DA

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AMENDMENTS

In the Title:

Please amend the previously presented title of the invention: "MULTI-CHIP MODULE PACKAGE" to "SEMICONDUCTOR PACKAGE WITH A HEAT SPREADER".